

300mA HIGH SPEED, EXTREMELY LOW NOISE CMOS LDO REGULATOR
Description

The AP2127 Series are positive voltage regulator ICs fabricated by CMOS process.

The AP2127 Series have features of low dropout voltage, low noise, high output voltage accuracy, and low current consumption which make them ideal for use in various battery-powered devices.

AP2127 has 1.0V, 1.2V, 1.5V, 1.8V, 2.5V, 2.8V, 3.0V, 3.3V, 4.2V, 4.75V, 5.2V fixed voltage versions and 0.8V to 5.5V adjustable voltage versions.

AP2127 Series are available in SOT-23 (for fixed versions only), SOT-23-3 (for fixed versions only), SOT-23-5, SOT-89 (for fixed versions only) and DFN-2x2-6 packages.

Applications

- Datacom
- Notebook Computers
- Mother Board

Notes:

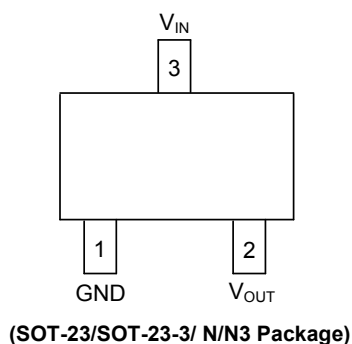
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Features

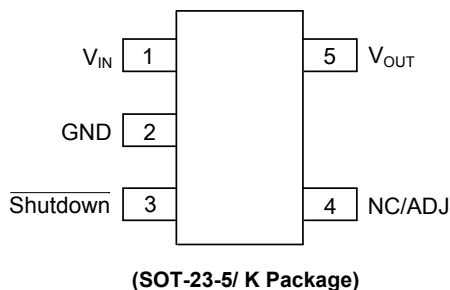
- Wide Operating Voltage: 2.5V to 6V
- High Output Voltage Accuracy: $\pm 2\%$
- High Ripple Rejection:
68dB @ $f = 1\text{kHz}$, 54dB @ $f = 10\text{kHz}$
- Low Standby Current: 0.1 μA
- Low Dropout Voltage: 170mV @ 300mA for $V_{\text{OUT}} = 3.3\text{V}$, 140mV @ 300mA for $V_{\text{OUT}} = 5.2\text{V}$
- Low Quiescent Current: 60 μA Typical
- Low Output Noise: 60 μV_{RMS} @ $V_{\text{OUT}} = 0.8\text{V}$
- Short Current Limit: 50mA
- Over Temperature Protection
- Compatible with Low ESR Ceramic Capacitor:
1 μF for C_{IN} and C_{OUT}
- Excellent Line/Load Regulation
- Soft Start Time: 50 μs
- Auto Discharge Resistance: $R_{\text{DS(ON)}} = 60\Omega$
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Pin Assignments

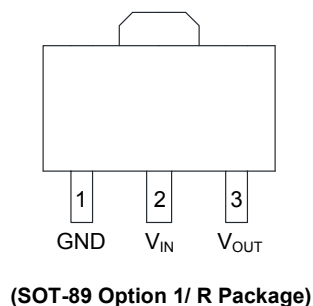
(Top View)



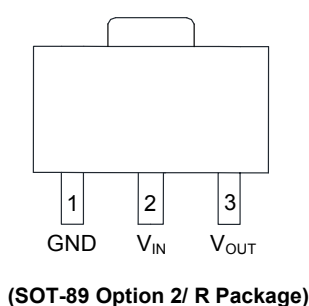
(Top View)



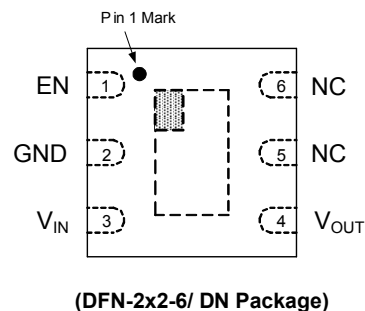
(Top View)



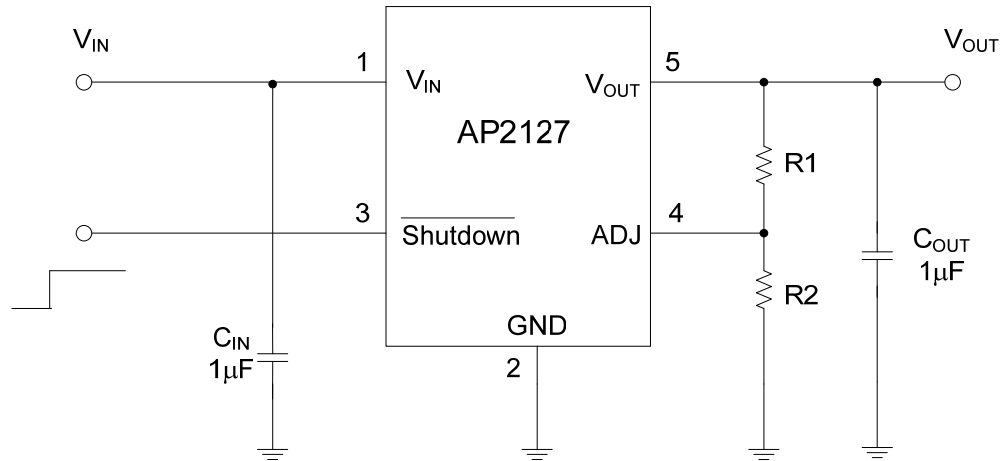
(Top View)



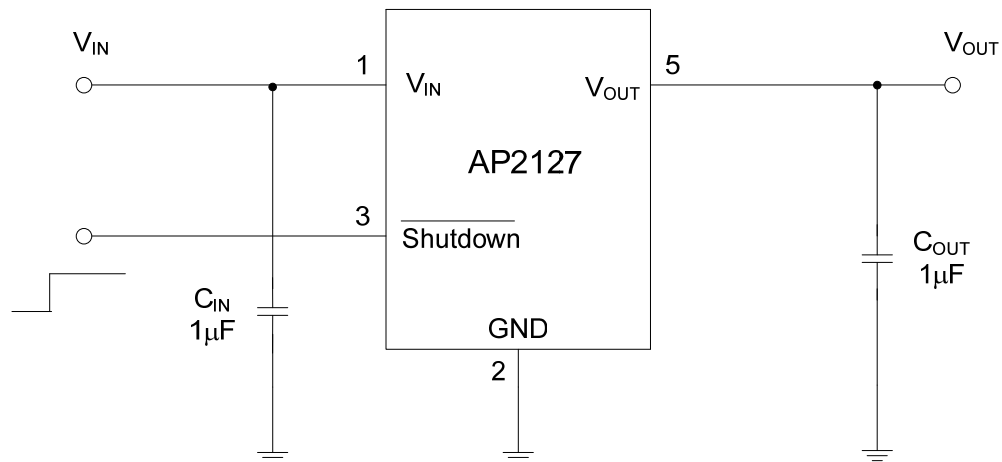
(Top View)



Typical Applications Circuit

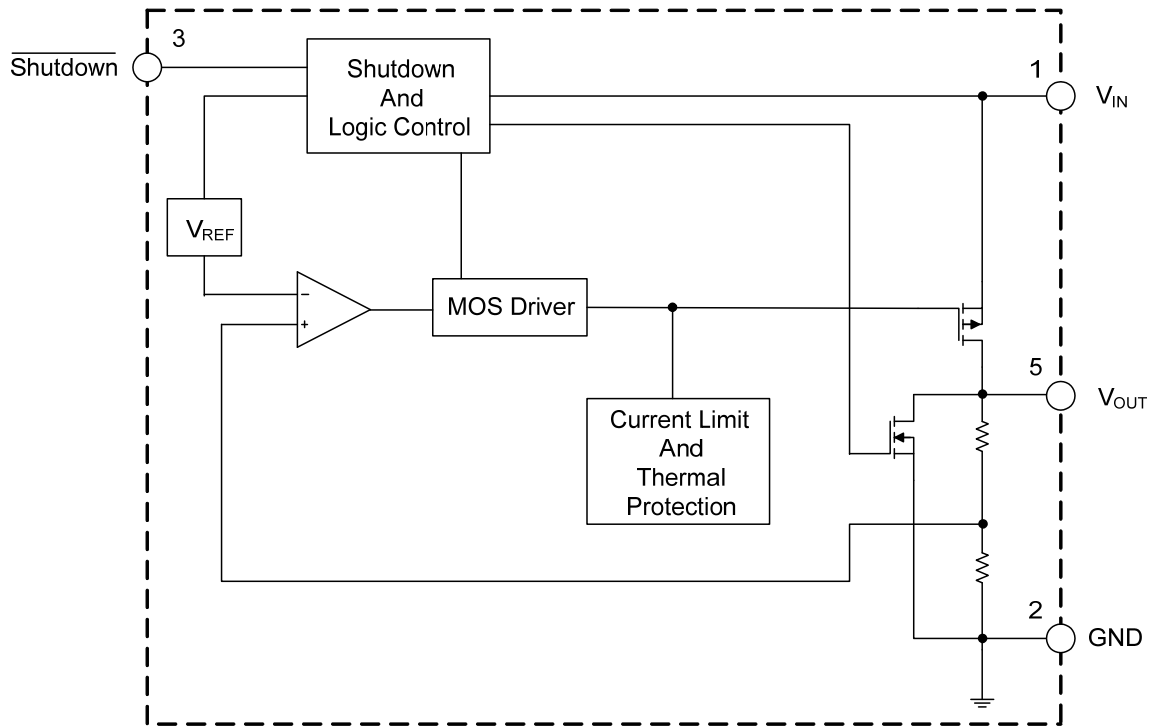


$$V_{OUT} = 0.8(1 + R1/R2)V$$

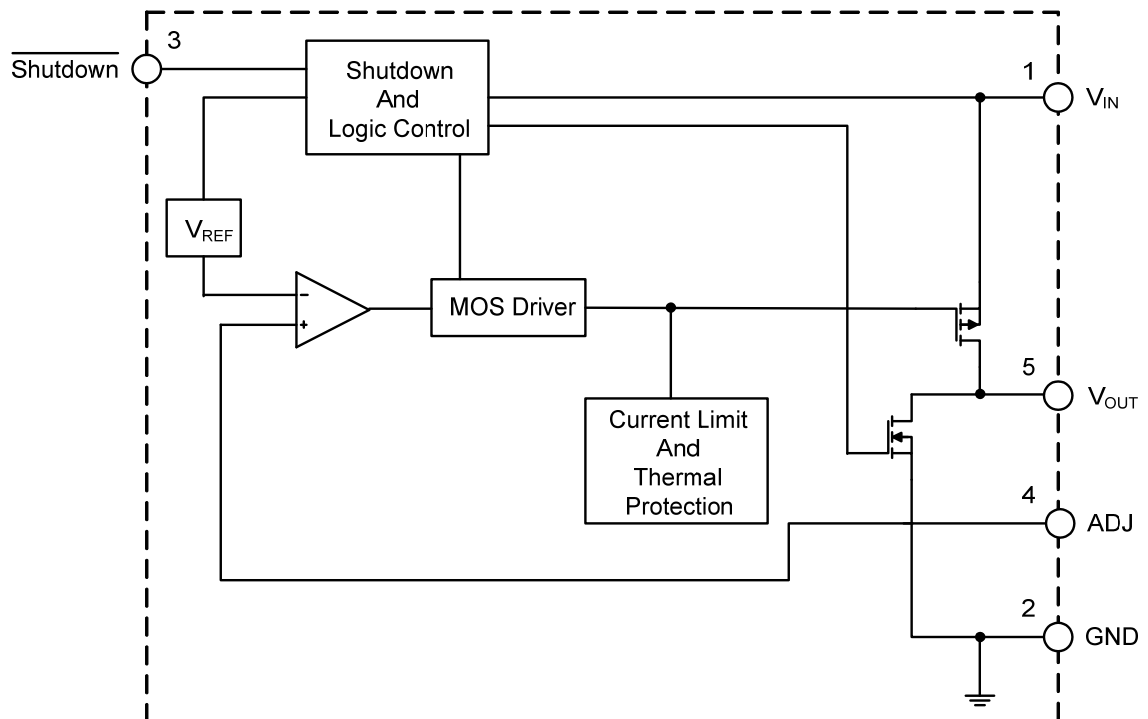


For 1.0V to 5.2V Fixed Voltage Versions

Functional Block Diagram



Fixed Version (SOT-23-5 Package)



Adjustable Version (SOT-23-5 Package)

Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Parameter	Symbol	Value	Unit
Input Voltage	V _{IN}	6.5	V
Shutdown Input Voltage	V _{CE}	-0.3 to V _{IN} +0.3	V
Output Current	I _{OUT}	450	mA
Junction Temperature	T _J	+150	°C
Storage Temperature Range	T _{STG}	-65 to +150	°C
Lead Temperature (Soldering, 10sec)	T _{LEAD}	+260	°C
Thermal Resistance (Junction to Ambient)	θ _{JA}	SOT-23	180
		SOT-23-3	250
		SOT-23-5	250
		SOT-89	100
		DFN-2X2-6	85
ESD (Human Body Model)	ESD	6000	V
ESD (Machine Model)	ESD	200	V

Note: 4. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Max	Unit
Input Voltage	V _{IN}	2.5	6	V
Operating Ambient Temperature Range	T _A	-40	+85	°C

Electrical Characteristics (V_{IN} = 2.5V (for 0.8V to 1.8V voltage versions), V_{IN} = V_{OUT} +1V (for 2.5V to 4.75V voltage versions), V_{IN} = 6V @ V_{OUT} = 5.2V, T_A = +25°C, C_{IN} = 1μF, C_{OUT} = 1μF, **Bold** typeface applies over -40°C ≤ T_A ≤ +85°C unless otherwise specified.)

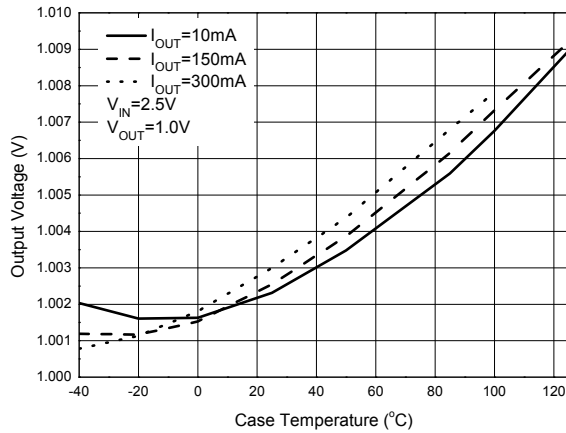
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reference Voltage	V _{REF}	V _{IN} = V _{OUT} +1V 1mA ≤ I _{OUT} ≤ 300mA	0.784	0.8	0.816	V
Output Voltage	V _{OUT}	V _{IN} = V _{OUT} +1V 1mA ≤ I _{OUT} ≤ 300mA	98% x V _{OUT}	–	102% x V _{OUT}	V
Input Voltage	V _{IN}	–	2.5	–	6	V
Maximum Output Current	I _{OUT(MAX)}	V _{IN} = V _{OUT} = 1V V _{OUT} = 0.98 x V _{OUT}	300	400	–	mA
Load Regulation	ΔV _{OUT}	V _{IN} = V _{OUT} = 1V 1mA ≤ I _{OUT} ≤ 300mA	–	4	10	mV
Line Regulation	ΔV _{OUT}	V _{OUT} + 0.5V ≤ V _{IN} ≤ 6V I _{OUT} = 30mA	–	0.5	5	mV
Dropout Voltage	V _{DROP}	V _{OUT} = 1.0V, I _{OUT} = 300mA	–	1400	1500	mV
		V _{OUT} = 1.2V, I _{OUT} = 300mA	–	1200	1300	
		V _{OUT} = 1.5V, I _{OUT} = 300mA	–	900	1000	
		V _{OUT} = 1.8V, I _{OUT} = 300mA	–	600	700	
		V _{OUT} = 2.5V, 2.8V, 3.0V, 3.3V, 4.2V, I _{OUT} = 300mA	–	170	300	
		V _{OUT} = 4.75 and 5.2V, I _{OUT} = 300mA	–	140	300	
Quiescent Current	I _Q	V _{IN} = V _{OUT} +1V, I _{OUT} = 0mA	–	60	90	μA
Standby Current	I _{STD}	V _{IN} = V _{OUT} +1V V _{SHUTDOWN} in off mode	–	0.1	1.0	μA

Electrical Characteristics ($V_{IN} = 2.5V$ (for 0.8V to 1.8V voltage versions), $V_{IN} = V_{OUT} + 1V$ (for 2.5V to 4.75V voltage versions), $V_{IN} = 6V$ @ $V_{OUT} = 5.2V$, $T_A = +25^\circ C$, $C_{IN} = 1\mu F$, $C_{OUT} = 1\mu F$, **Bold** typeface applies over $-40^\circ C \leq T_A \leq +85^\circ C$ unless otherwise specified.)

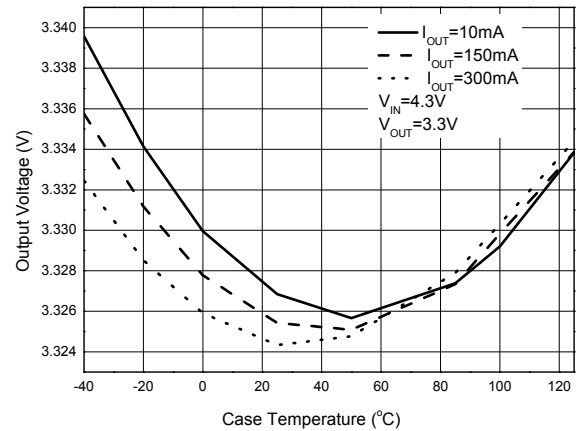
Parameter	Symbol	Conditions		Min	Typ	Max	Unit
Power Supply Rejection Ration	PSRR	AP2127-1.0V to 4.2V, Ripple 1V _{P-P} V _{IN} = V _{OUT} +1V	f = 100Hz	–	68	–	dB
			f = 1kHz	–	68	–	dB
			f = 10kHz	–	54	–	dB
		AP2127-4.75V and 5.2V, Ripple 0.5V _{P-P} V _{IN} = V _{OUT} +1V	f = 100Hz	–	63	–	dB
			f = 1kHz	–	63	–	dB
			f = 10kHz	–	45	–	dB
Output Voltage Temperature Coefficient	ΔV _{OUT} /V _{OUT} /ΔT	I _{OUT} = 30mA, -40°C ≤ T _A ≤ +85°C		–	±100	–	ppm/°C
Short Current Limit	I _{SHORT}	V _{OUT} = 0V		–	50	–	mA
Soft Start Time	t _{SS}	–		–	50	–	μs
RMS Output Noise	V _{NOISE}	T _A = +25°C, 10Hz ≤ f ≤ 100kHz, V _{OUT} = 0.8V		–	60	–	μV _{RMS}
Shutdown High Voltage	–	Shutdown Input Voltage High		1.5	–	–	V
Shutdown Low Voltage	–	Shutdown Input Voltage Low		0	–	–	V
V _{OUT} Discharge MOSFET R _{DS(ON)}	–	Shutdown Input Voltage Low		–	60	–	Ω
Shutdown Pull Down Resistance	–	–		–	3	–	MΩ
Thermal Shutdown	–	–		–	+165	–	°C
Thermal Shutdown Hysteresis	–	–		–	+30	–	
Thermal Resistance	θ _{JC}	SOT-23		–	100	–	°C/W
		SOT-23-3		–	150	–	
		SOT-23-5		–	150	–	
		SOT-89		–	75	–	
		DFN-2x2-6		–	60	–	

Performance Characteristics

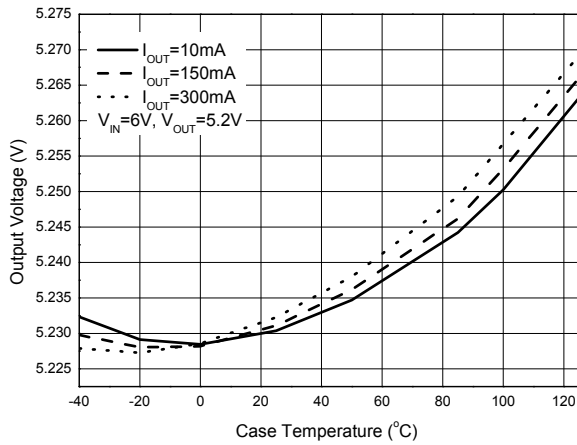
Output Voltage vs. Case Temperature



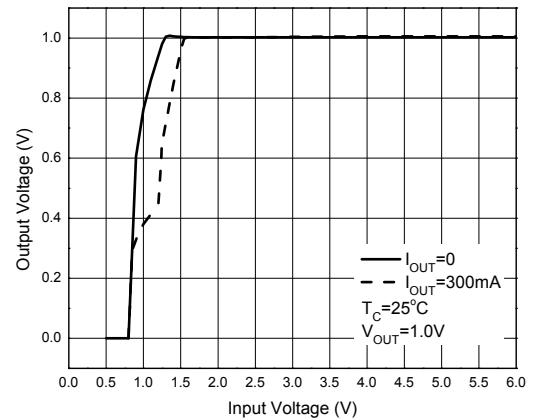
Output Voltage vs. Case Temperature



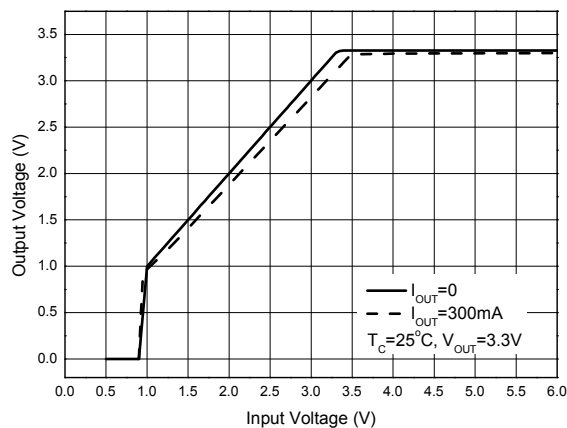
Output Voltage vs. Case Temperature



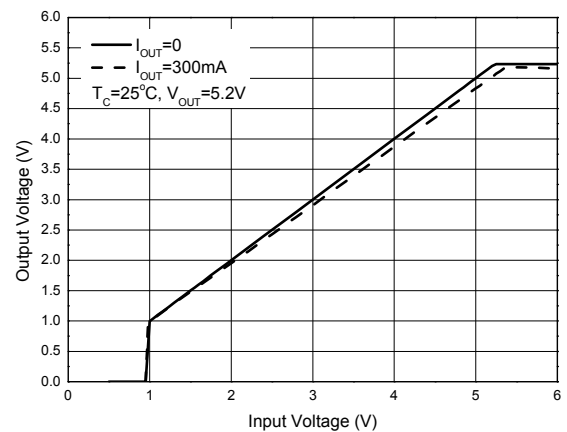
Output Voltage vs. Input Voltage



Output Voltage vs. Input Voltage

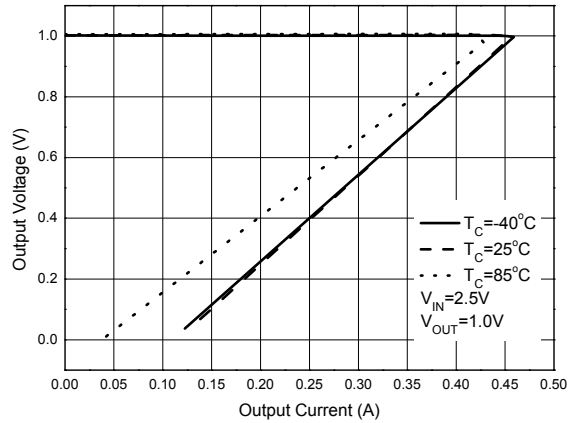


Output Voltage vs. Input Voltage

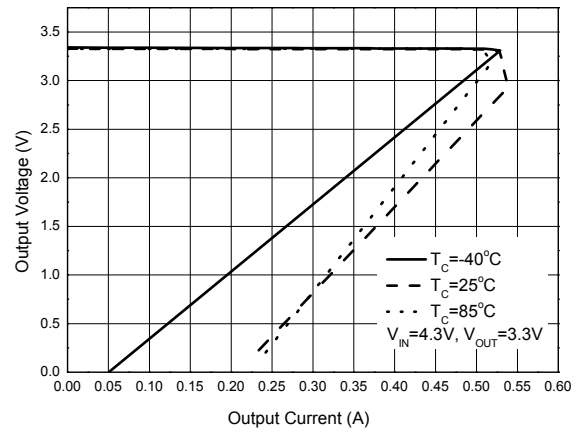


Performance Characteristics (cont.)

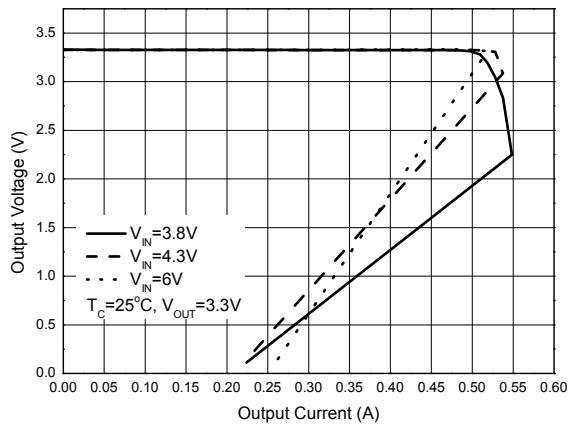
Output Voltage vs. Output Current



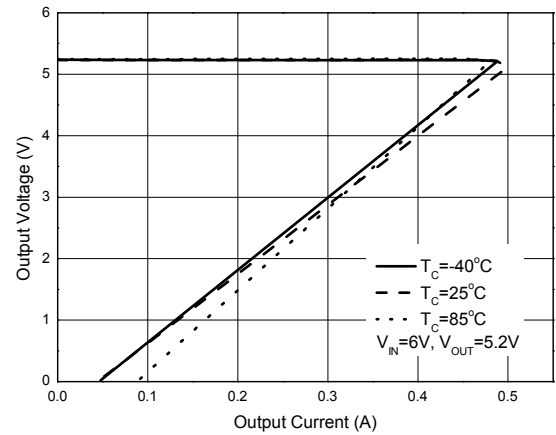
Output Voltage vs. Output Current



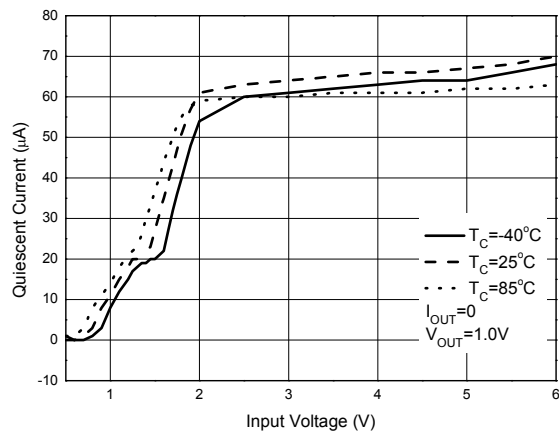
Output Voltage vs. Output Current



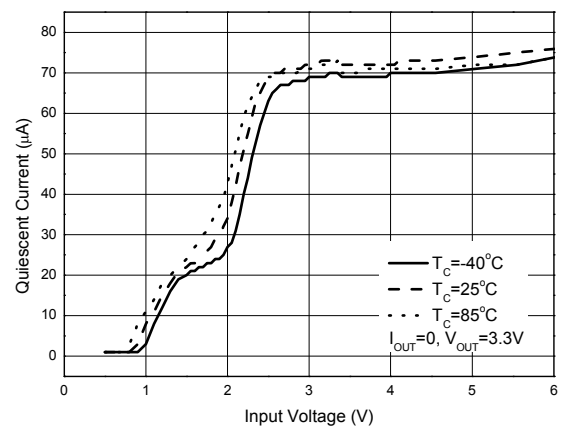
Output Voltage vs. Output Current



Quiescent Current vs. Input Voltage

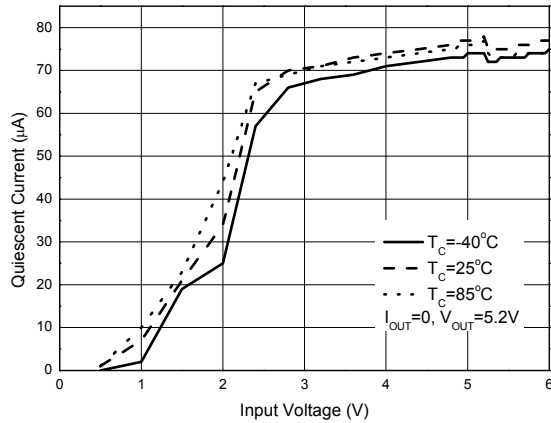


Quiescent Current vs. Input Voltage

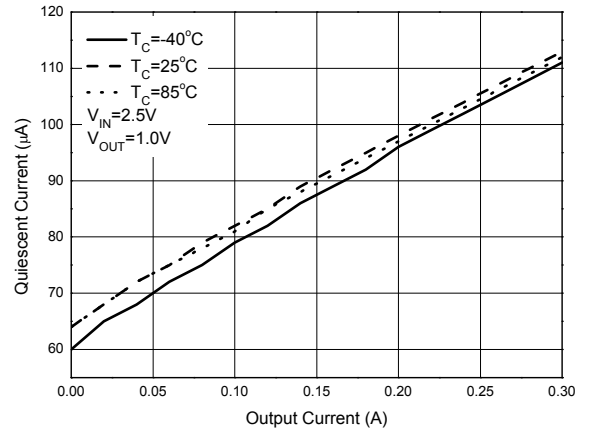


Performance Characteristics (cont.)

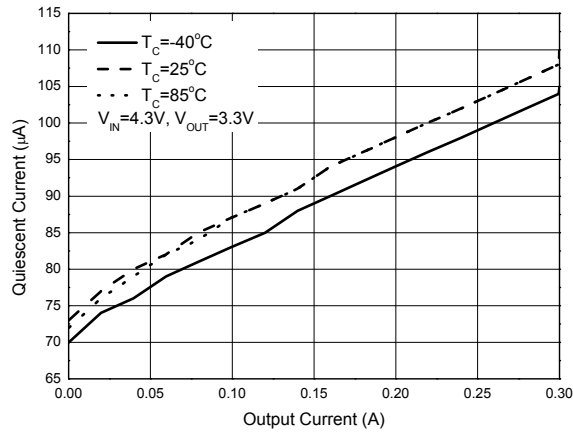
Quiescent Current vs. Input Voltage



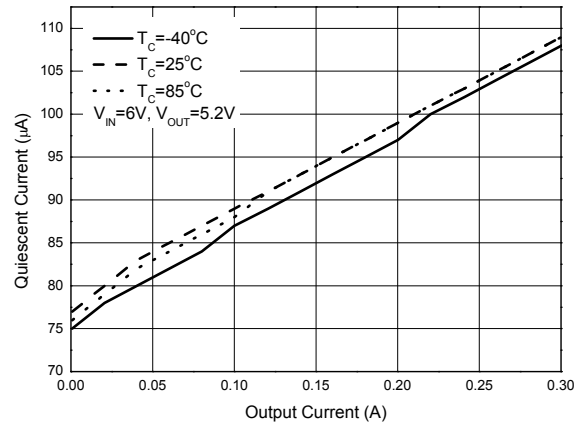
Quiescent Current vs. Output Current



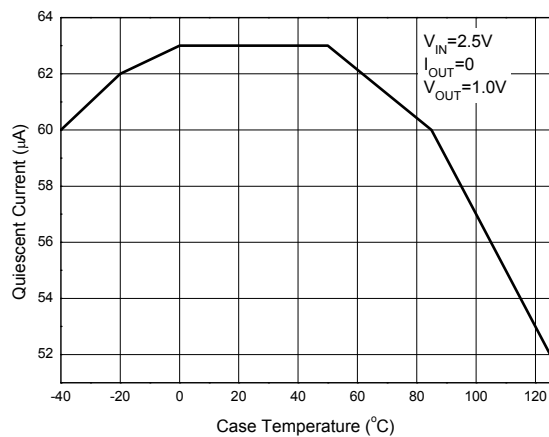
Quiescent Current vs. Output Current



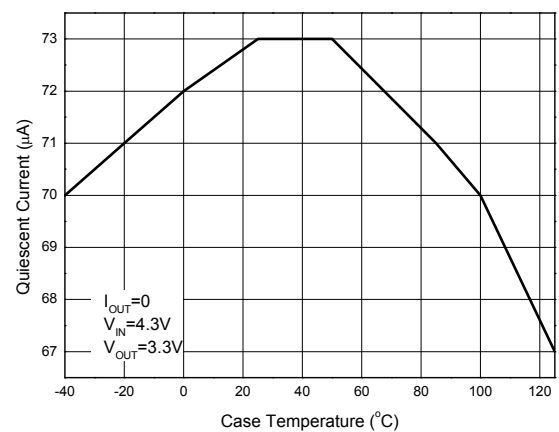
Quiescent Current vs. Output Current



Quiescent Current vs. Case Temperature

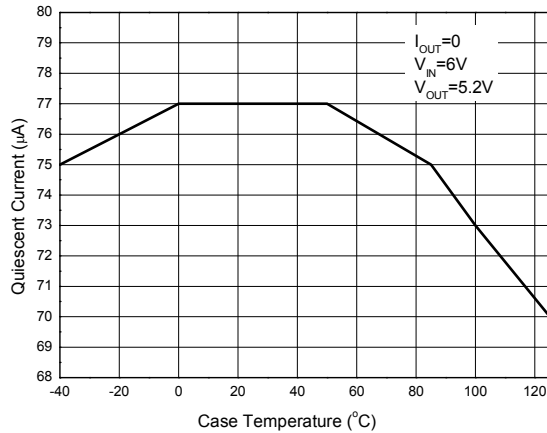


Quiescent Current vs. Case Temperature

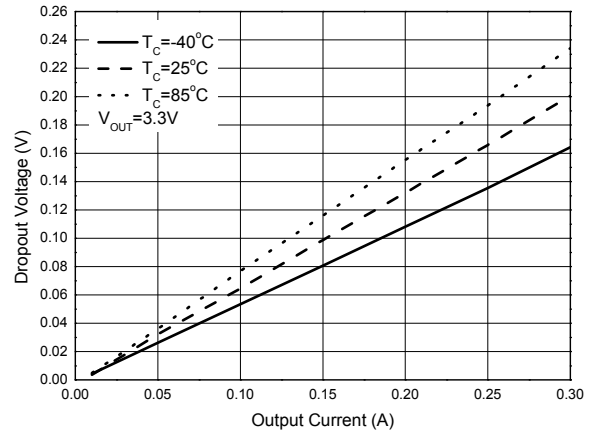


Performance Characteristics (cont.)

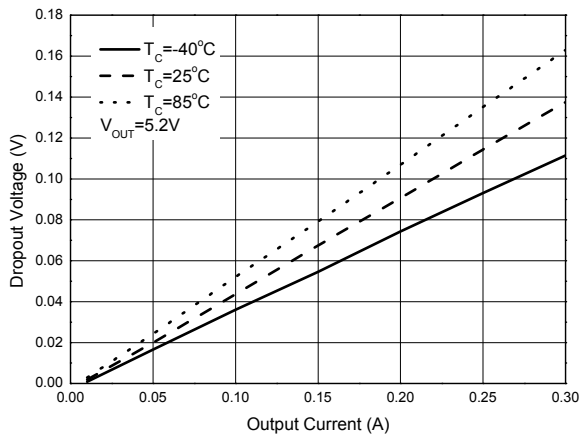
Quiescent Current vs. Case Temperature



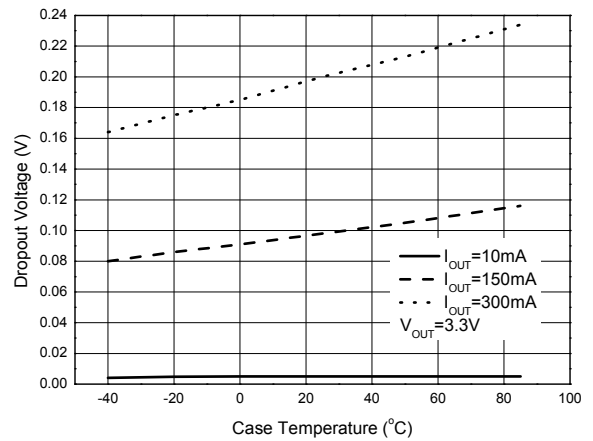
Dropout Voltage vs. Output Current



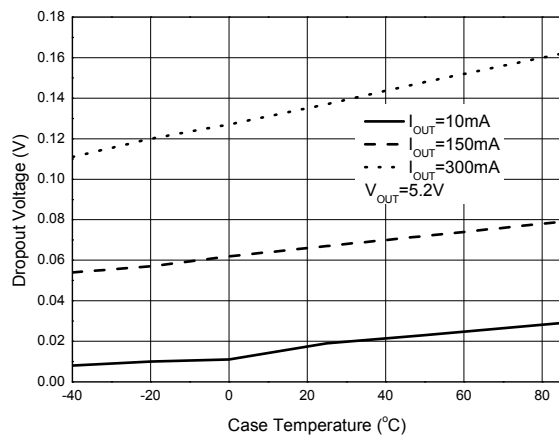
Dropout Voltage vs. Output Current



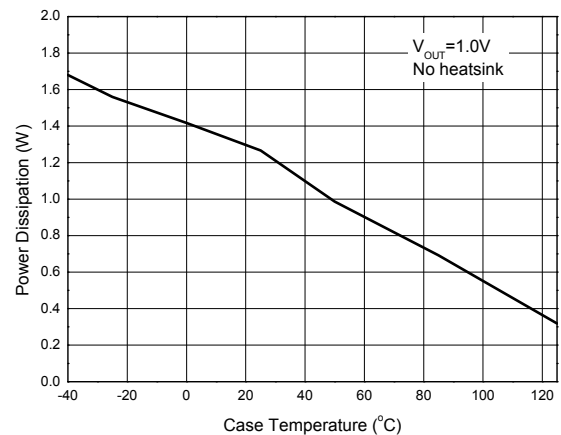
Dropout Voltage vs. Case Temperature



Dropout Voltage vs. Case Temperature

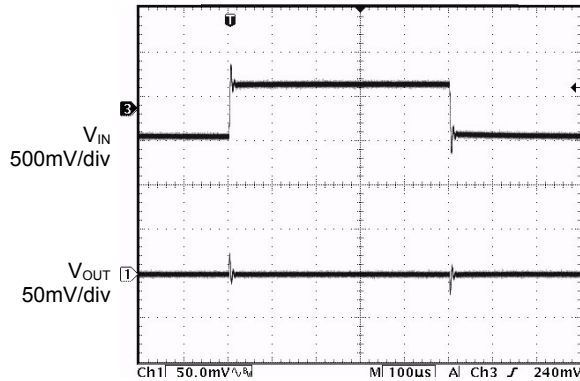


Power Dissipation vs. Case Temperature

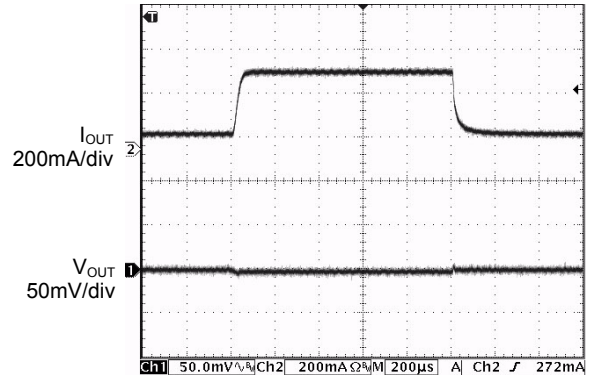


Performance Characteristics (cont.)

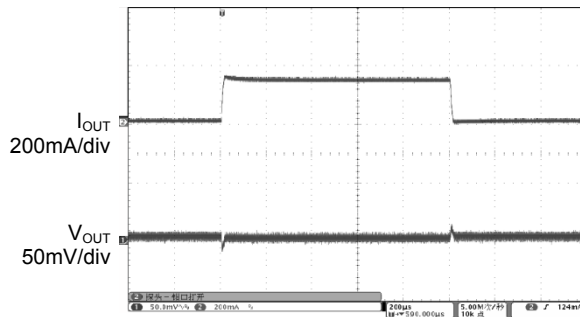
Line Transient
(Condition: $C_{IN}=C_{OUT}=1\mu F$, $I_{OUT}=10mA$,
 $V_{IN}=2.5V$ to $3.3V$, $V_{OUT}=1V$)



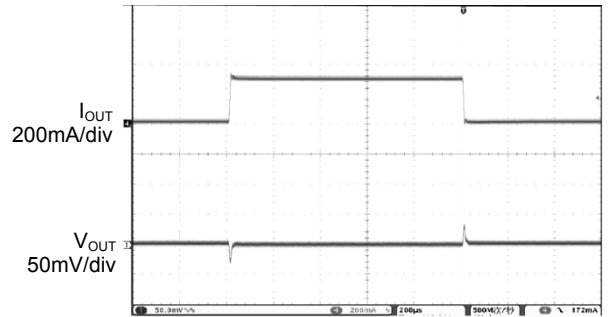
Load Transient
(Condition: $C_{IN}=C_{OUT}=1\mu F$, Slew Rate= $20mA/\mu s$,
 $V_{IN}=2.5V$, $V_{OUT}=1V$, $I_{OUT}=10mA$ to $300mA$)



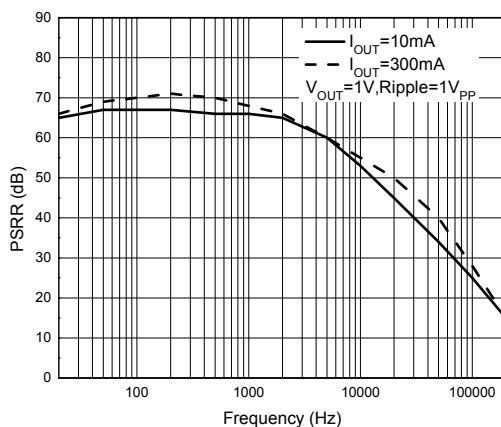
Load Transient
(Condition: $C_{IN}=C_{OUT}=1\mu F$, $I_{OUT}=10mA$ to $300mA$,
 $V_{IN}=4.3V$, $V_{OUT}=3.3V$)



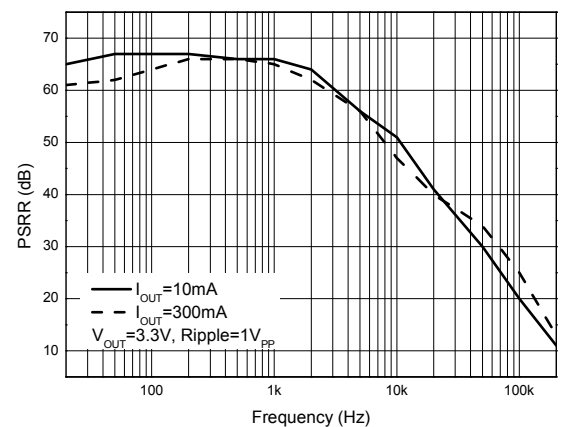
Load Transient
(Condition: $C_{IN}=C_{OUT}=1\mu F$, Slew Rate= $20mA/\mu s$,
 $V_{IN}=6V$, $V_{OUT}=5.2V$, $I_{OUT}=10mA$ to $300mA$)



PSRR vs. Frequency
(Condition: $C_{IN}=C_{OUT}=1\mu F$, $V_{IN}=2.5V$, $V_{OUT}=1V$
Ripple= $1V_{PP}$)

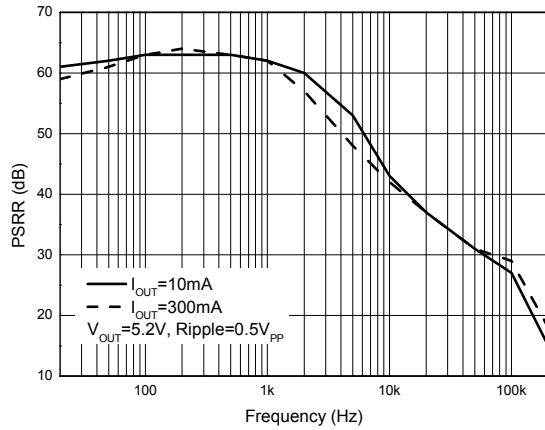


PSRR vs. Frequency
(Condition: $C_{IN}=C_{OUT}=1\mu F$, $V_{IN}=4.3V$, $V_{OUT}=3.3V$,
Ripple= $1V_{PP}$)

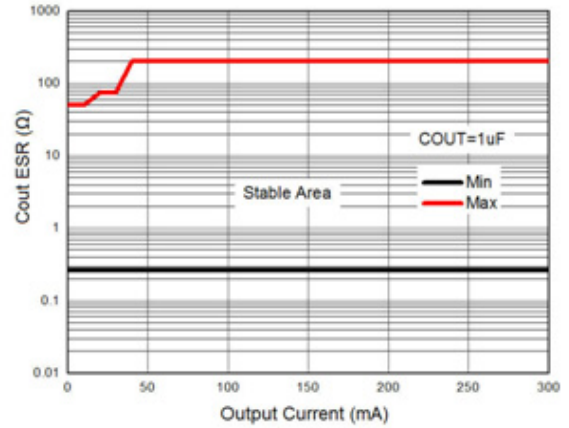


Performance Characteristics (Cont.)

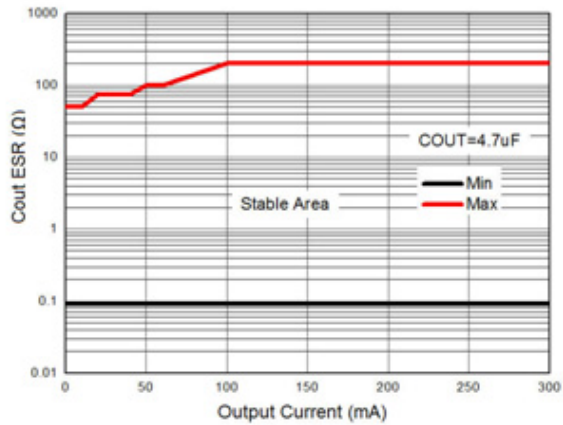
PSRR vs. Frequency
(Condition: $C_{IN}=C_{OUT}=1\mu F$, $V_{IN}=6V$, $V_{OUT}=5.2V$,
Ripple= $0.5V_{PP}$)



Region of Stable C_{OUT} ESR vs. Output Current ($C_{OUT} = 1\mu F$)



Region of Stable C_{OUT} ESR vs. Output Current ($C_{OUT} = 4.7\mu F$)



Application Notes

Input Capacitor

A 1 μ F ceramic capacitor is recommended to connect between V_{IN} and GND pins to decouple input power supply glitch and noise. The amount of the capacitance may be increased without limit. This input capacitor must be located as close as possible to the device to assure input stability and less noise. For PCB layout, a wide copper trace is required for both V_{IN} and GND.

Output Capacitor

The output capacitor is required to stabilize and help transient response for LDO. The AP2127 is stable with very small ceramic output capacitor with a low ESR 1 μ F or higher of X7R or X5R MLCC capacitor, which will be sufficient at full temperature ranges. Additional capacitance helps to reduce undershoot and overshoot during transient. Place output capacitor as close as possible to V_{OUT} and GND pins, and keep the leads as short as possible.

Adjustable Operation

For adjustable version, the output voltage is calculated by:

$$V_{OUT} = V_{REF} \left(1 + \frac{R_1}{R_2} \right)$$

Where $V_{REF} = 0.8V$ (the internal reference voltage)

Rearranging the equation will give the following that is used for adjusting the output to a particular voltage:

$$R_1 = R_2 \left(\frac{V_{OUT}}{V_{REF}} - 1 \right)$$

For AP2127, the resistor at the low side (R_2) can be selected from 5k Ω to 200k Ω .

In order to improve the stability and to decrease the noise level of the adjustable version, a feed-forward capacitor is suggested to be placed between V_{OUT} and ADJ pins (Figure 1). It's recommended that this feed-forward capacitor value can be calculated as:

$$0.7kHz \leq \frac{1}{2\pi \times R_1 \times C_{ff}} \leq 15kHz$$

The recommended value of the feed-forward capacitor for different resistor divider ratios is shown in the table below.

Output Voltage	R1	R2	C _{ff}
1.2V	7.5k Ω	15k Ω	2.7nF
1.6V	7.5k Ω	7.5k Ω	2.7nF
1.8V	22.5k Ω	18k Ω	1nF
1.9V	7.5k Ω	5.49k Ω	2.7nF
2.5V	38.3k Ω	18k Ω	560pF
3.3V	56.2k Ω	18k Ω	390pF
4.0V	120k Ω	30.1k Ω	180pF

Table 1 Output Voltage Setting Guide

Application Notes (cont.)

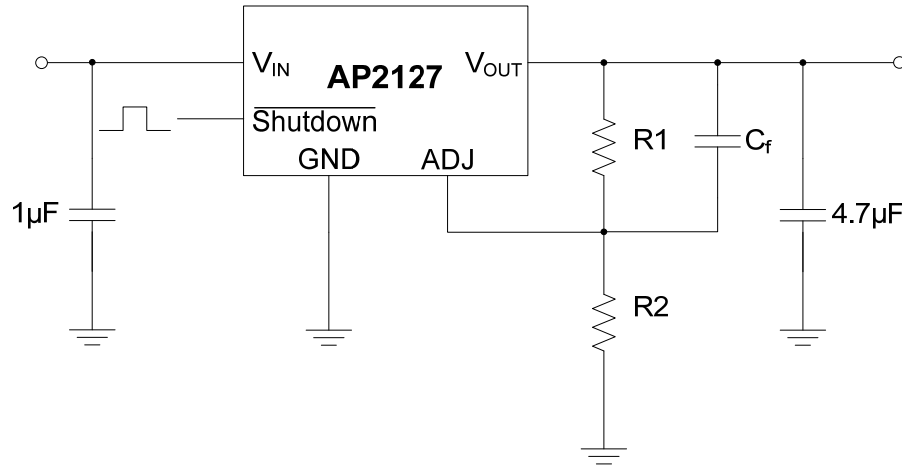


Figure 1. Application Circuit with Feed-forward Capacitor

Current Limit Protection

When output current at V_{OUT} pin is higher than current limit threshold, the current limit protection will be triggered and clamp the output current to prevent over-current and to protect the regulator and load from damaged due to overheating.

Short Circuit Protection

When V_{OUT} pin is shorted to GND, short circuit protection will be triggered and clamp the output current to approximately 50mA.

Auto discharge with Shutdown Version

For shutdown version, an auto discharge MOSFET with $R_{DS(ON)}$ of 60Ω typical is integrated between V_{OUT} and GND pins, which can discharge the charge of the output capacitors quickly when turning off AP2127 with Shutdown pin.

Thermal Consideration

Internal thermal protection circuitry of AP2127 is used to protect device during overload conditions. For continuous operation, ensure not to exceed the operating junction temperature range of +125°C.

The power dissipation definition in the device is:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{IN} \times I_Q$$

The maximum power dissipation depends on the thermal resistance of IC package, PCB layout and the surrounding airflow. The maximum power dissipation can also be calculated as:

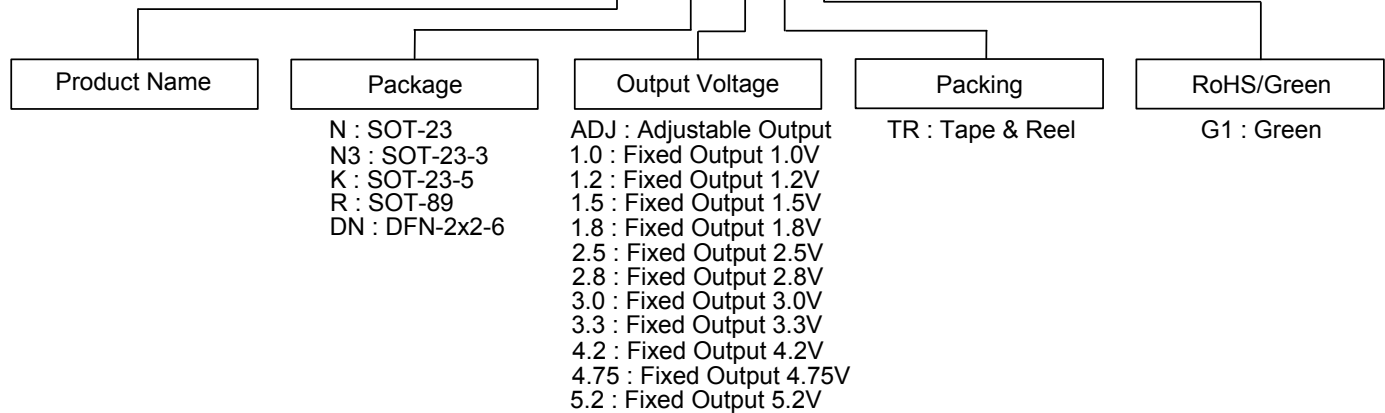
$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

The maximum power dissipation for SOT-23-5 package (least copper size) at $T_A = +25^\circ\text{C}$ can be calculated as:

$$P_{D(MAX)} = (125^\circ\text{C} - 25^\circ\text{C}) / (250^\circ\text{C/W}) = 0.4\text{W}$$

Ordering Information

AP2127 XX - XX XX XX



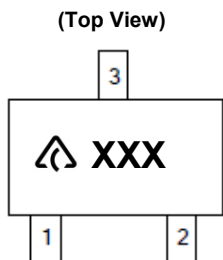
Part Number	Marking ID	Temperature Range	Package	Package
AP2127N-1.0TRG1	GU8	-40°C to +85°C	SOT-23	3000/Tape & Reel
AP2127N-1.2TRG1	GS8			3000/Tape & Reel
AP2127N-1.5TRG1	GV8			3000/Tape & Reel
AP2127N-1.8TRG1	GW8			3000/Tape & Reel
AP2127N-2.5TRG1	GT9			3000/Tape & Reel
AP2127N-2.8TRG1	GU9			3000/Tape & Reel
AP2127N-3.0TRG1	GV9			3000/Tape & Reel
AP2127N-3.3TRG1	GW9			3000/Tape & Reel
AP2127N-4.2TRG1	GS9			3000/Tape & Reel
AP2127N-4.75TRG1	GV7			3000/Tape & Reel
AP2127N-5.2TRG1	GW7			3000/Tape & Reel
AP2127N3-1.0TRG1	GU1		SOT-23-3	3000/Tape & Reel
AP2127N3-1.2TRG1	GU2			3000/Tape & Reel
AP2127N3-1.5TRG1	GU3			3000/Tape & Reel
AP2127N3-1.8TRG1	GU4			3000/Tape & Reel
AP2127N3-2.5TRG1	GU5			3000/Tape & Reel
AP2127N3-2.8TRG1	GV1			3000/Tape & Reel
AP2127N3-3.0TRG1	GV2			3000/Tape & Reel
AP2127N3-3.3TRG1	GV3			3000/Tape & Reel
AP2127N3-4.2TRG1	GV4			3000/Tape & Reel
AP2127N3-4.75TRG1	GV5			3000/Tape & Reel
AP2127N3-5.2TRG1	GW1			3000/Tape & Reel
AP2127K-ADJTRG1	GEH		SOT-23-5	3000/Tape & Reel
AP2127K-1.0TRG1	GEG			3000/Tape & Reel
AP2127K-1.5TRG1	GEP			3000/Tape & Reel
AP2127K-1.8TRG1	GEQ			3000/Tape & Reel
AP2127K-2.5TRG1	GER			3000/Tape & Reel
AP2127K-2.8TRG1	GES			3000/Tape & Reel
AP2127K-3.0TRG1	GHF			3000/Tape & Reel
AP2127K-3.3TRG1	GET			3000/Tape & Reel
AP2127K-4.2TRG1	GEU			3000/Tape & Reel
AP2127K-4.75TRG1	GEZ			3000/Tape & Reel
AP2127K-5.2TRG1	GEW			3000/Tape & Reel

Ordering Information (cont.)

Part Number	Marking ID	Temperature Range	Package	Package
AP2127R-1.0TRG1	G22P	-40°C to +85°C	SOT-89	1000/Tape & Reel
AP2127R-1.2TRG1	G27P			1000/Tape & Reel
AP2127R-1.5TRG1	G28P			1000/Tape & Reel
AP2127R-1.8TRG1	G31P			1000/Tape & Reel
AP2127R-2.5TRG1	G33P			1000/Tape & Reel
AP2127R-2.8TRG1	G37P			1000/Tape & Reel
AP2127R-3.0TRG1	G41P			1000/Tape & Reel
AP2127R-3.3TRG1	G42P			1000/Tape & Reel
AP2127R-4.2TRG1	G43P			1000/Tape & Reel
AP2127R-4.75TRG1	G70P			1000/Tape & Reel
AP2127R-5.2TRG1	G78P			1000/Tape & Reel
AP2127DN-ADJTRG1	BV		DFN-2x2-6	3000/Tape & Reel
AP2127DN-1.0TRG1	CA			3000/Tape & Reel
AP2127DN-1.2TRG1	CB			3000/Tape & Reel
AP2127DN-1.5TRG1	CC			3000/Tape & Reel
AP2127DN-1.8TRG1	CD			3000/Tape & Reel
AP2127DN-2.5TRG1	BP			3000/Tape & Reel
AP2127DN-2.8TRG1	BS			3000/Tape & Reel
AP2127DN-3.0TRG1	BU			3000/Tape & Reel
AP2127DN-3.3TRG1	CE			3000/Tape & Reel
AP2127DN-4.2TRG1	CF			3000/Tape & Reel
AP2127DN-4.75TRG1	CG			3000/Tape & Reel
AP2127DN-5.2TRG1	CH			3000/Tape & Reel

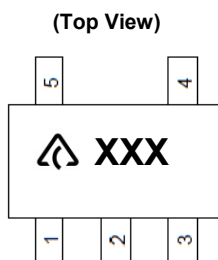
Marking Information

(1) SOT-23, SOT-23-3



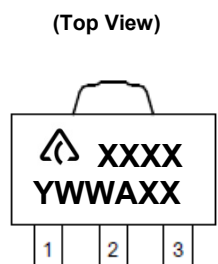
△ : Logo
XXX: Marking ID (See Ordering Information)

(2) SOT-23-5



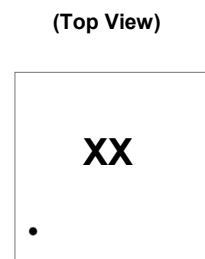
△ : Logo
XXX: Marking ID (See Ordering Information)

(3) SOT-89



First Line: Logo and Marking ID (See Ordering Information)
Second Line: Date Code
Y: Year
WW: Work Week of Molding
A: Assembly House Code
XX: 7th and 8th Digits of Batch Number

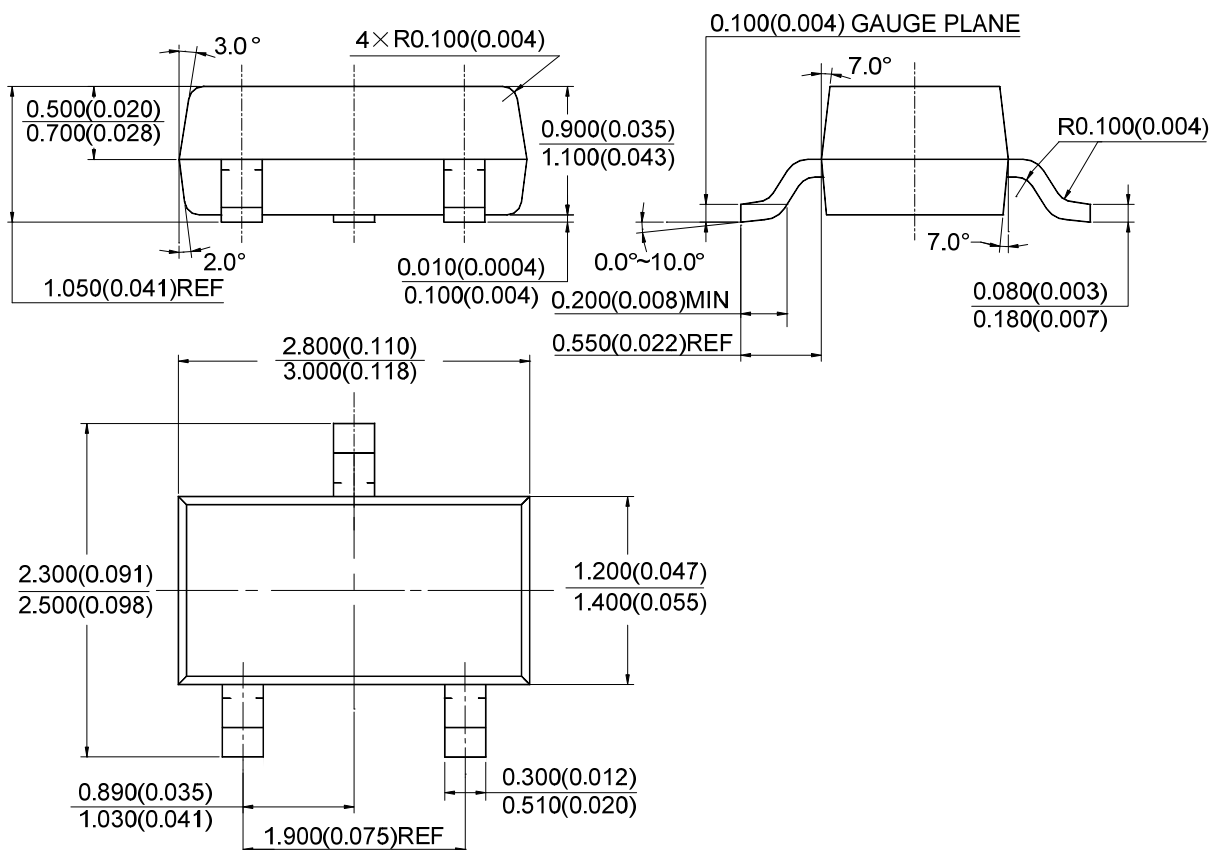
(4) DFN-2x2-6



XX: Marking ID (See Ordering Information)

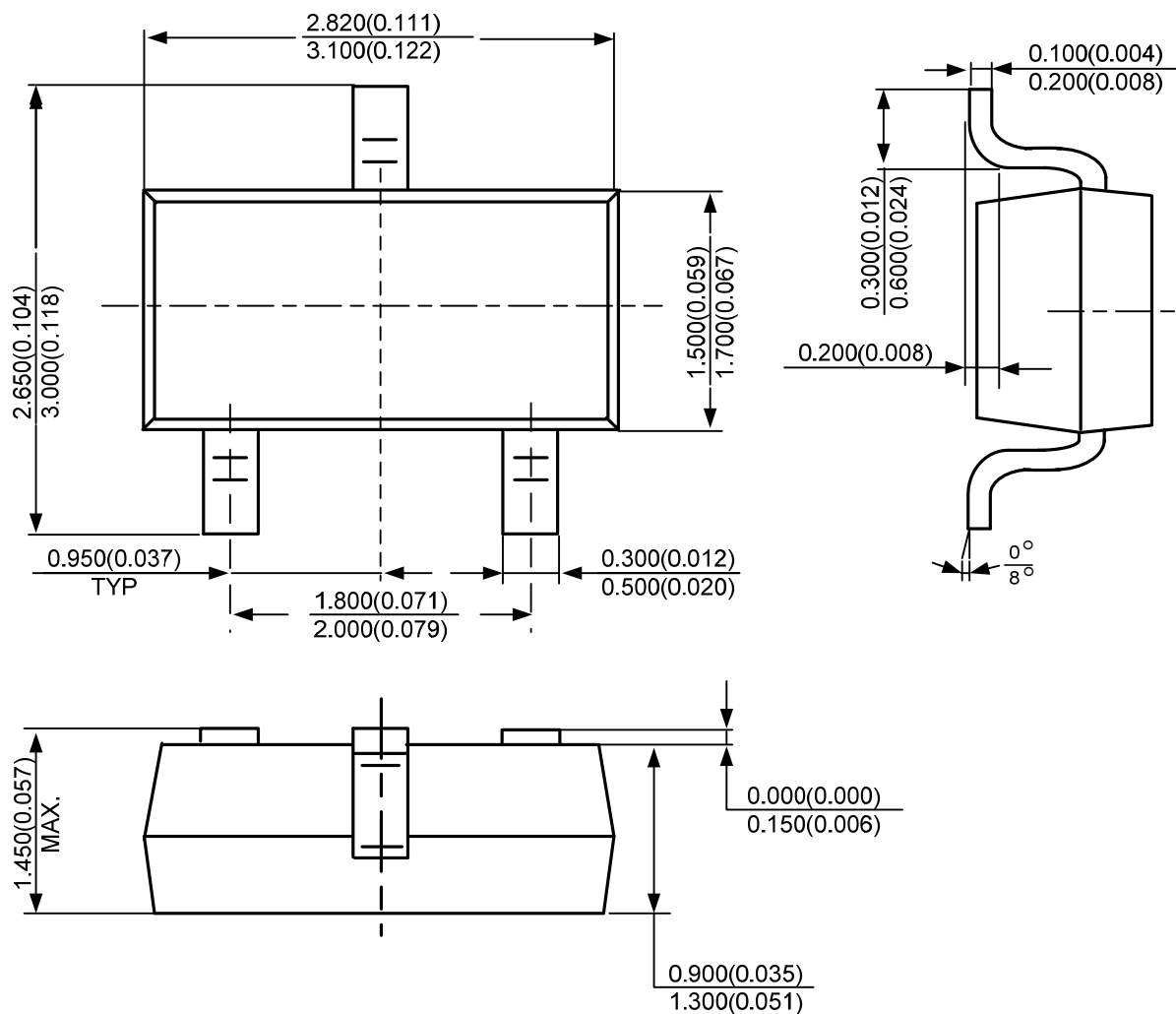
Package Outline Dimensions (All dimensions in mm.)

(1) Package Type: SOT-23



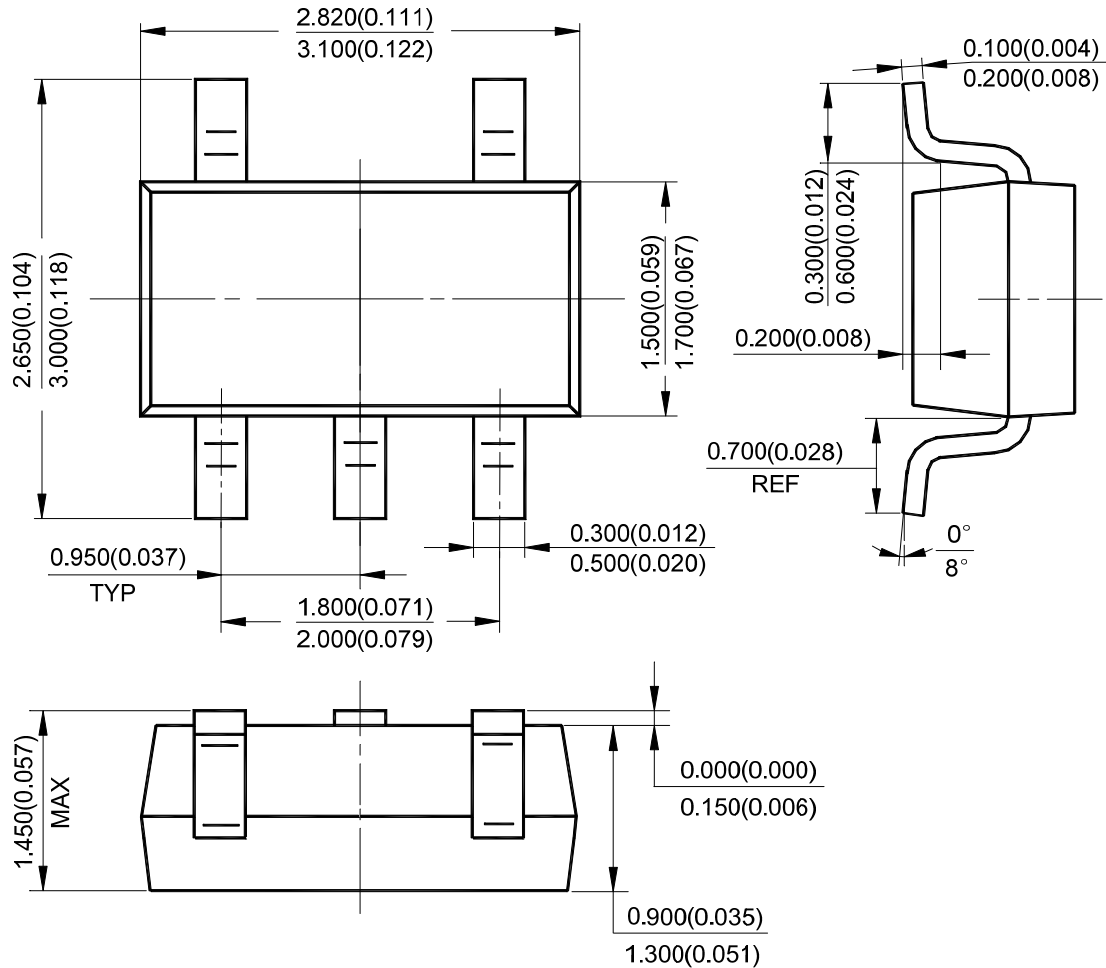
Package Outline Dimensions (cont.) (All dimensions in mm.)

(2) Package Type: SOT-23-3



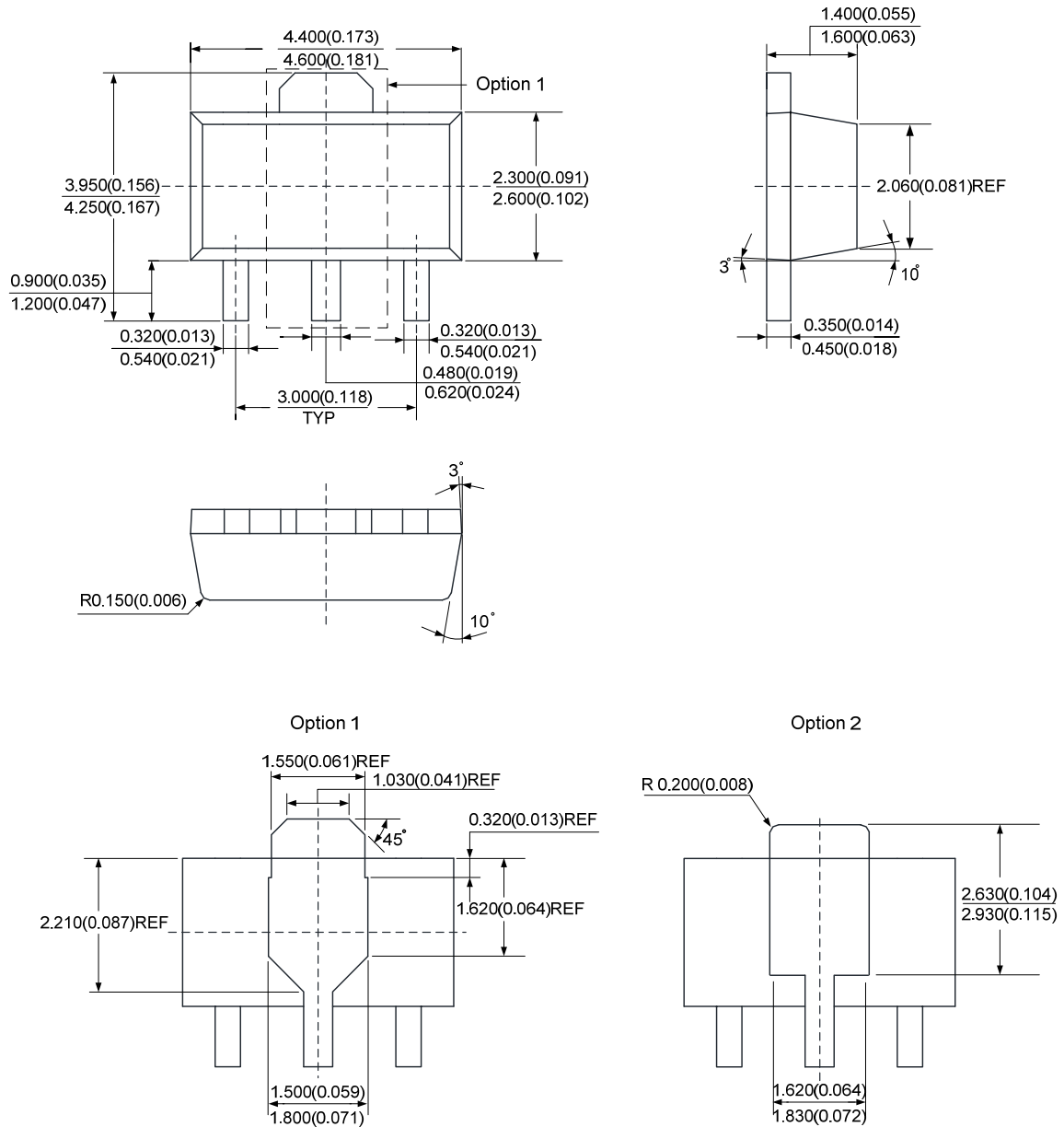
Package Outline Dimensions (cont.) (All dimensions in mm.)

(3) Package Type: SOT-23-5



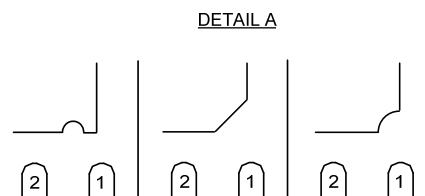
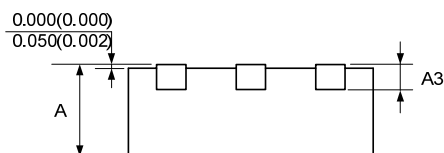
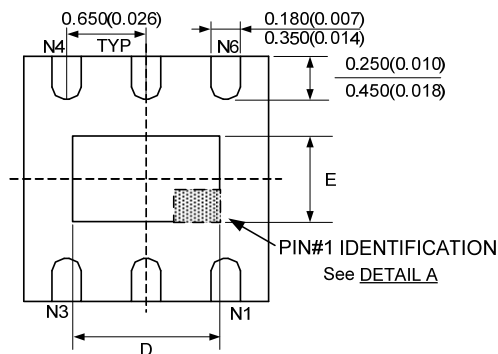
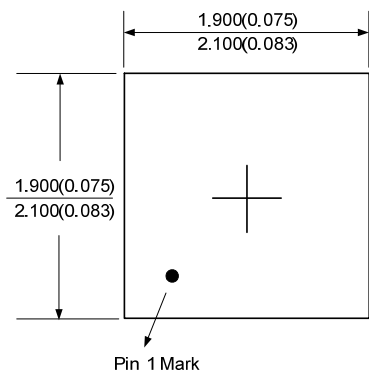
Package Outline Dimensions (cont.) (All dimensions in mm.)

(4) Package Type: SOT-89



Package Outline Dimensions (cont.) (All dimensions in mm.)

(5) Package Type: DFN-2x2-6

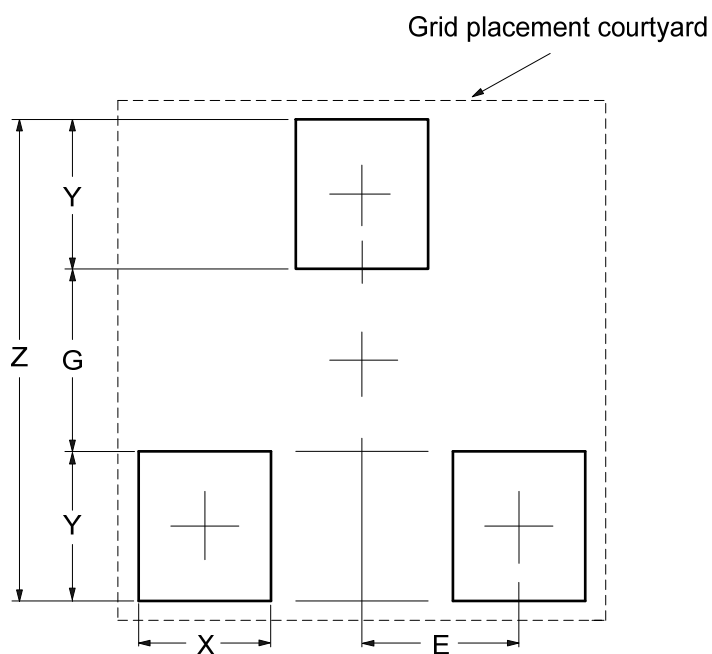


Pin 1 Options

Symbol	D				E			
	min(mm)	max(mm)	min(inch)	max(inch)	min(mm)	max(mm)	min(inch)	max(inch)
Option1	1.200 (TYP)		0.047 (TYP)		0.700 (TYP)		0.028 (TYP)	
Option2	1.550	1.750	0.061	0.069	0.860	1.060	0.034	0.042
Symbol	A				A3			
	min(mm)	max(mm)	min(inch)	max(inch)	min(mm)	max(mm)	min(inch)	max(inch)
Option1	0.700	0.800	0.028	0.031	0.203 (TYP)		0.008 (TYP)	
Option2	0.570	0.630	0.022	0.025	0.150 (TYP)		0.006 (TYP)	

Suggested Pad Layout (All dimensions in mm.)

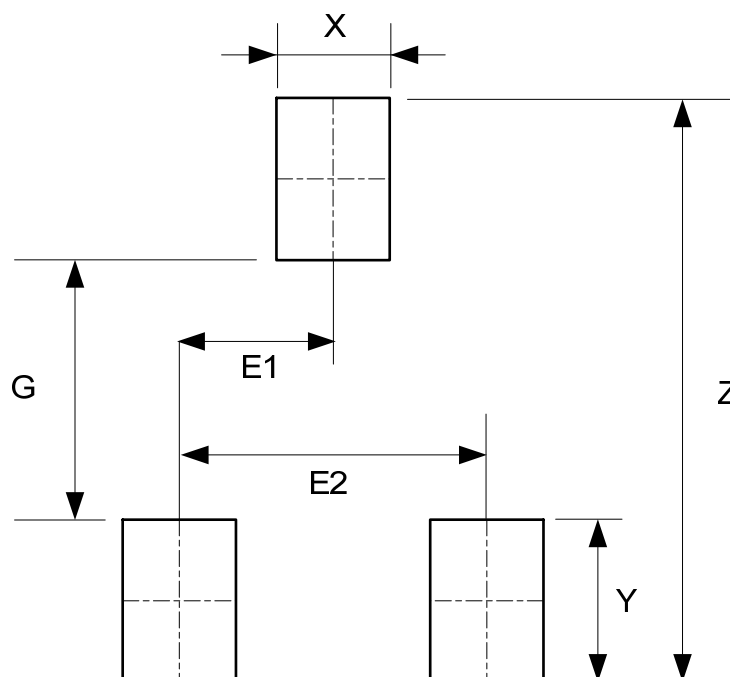
(1) Package Type: SOT-23



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E (mm)/(inch)
Value	2.900/0.114	1.100/0.043	0.800/0.031	0.900/0.035	0.950/0.037

Suggested Pad Layout (cont.) (All dimensions in mm.)

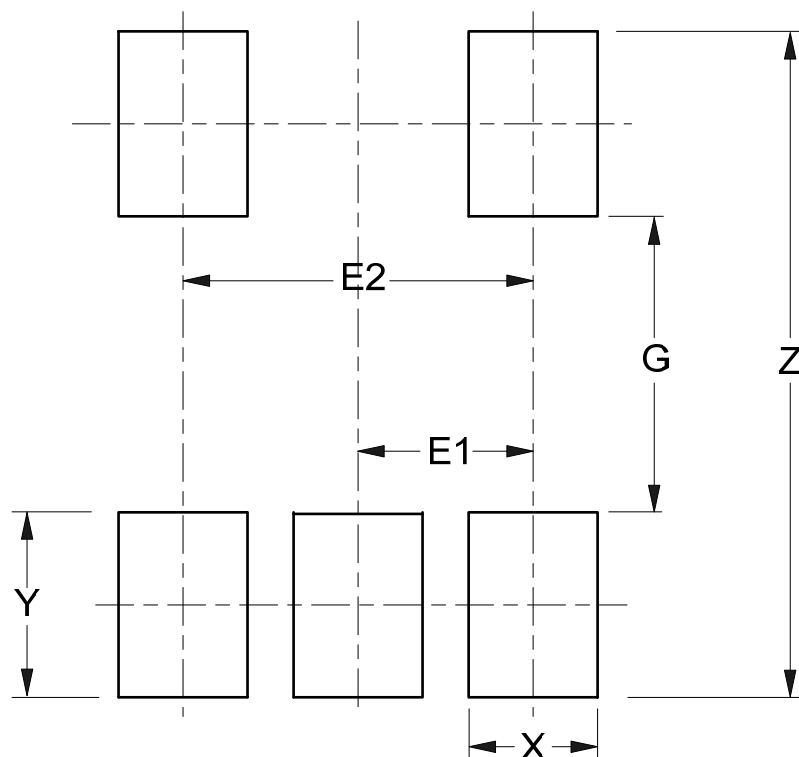
(2) Package Type: SOT-23-3



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E1 (mm)/(inch)	E2 (mm)/(inch)
Value	3.600/0.142	1.600/0.063	0.700/0.028	1.000/0.039	0.950/0.037	1.900/0.075

Suggested Pad Layout (cont.) (All dimensions in mm.)

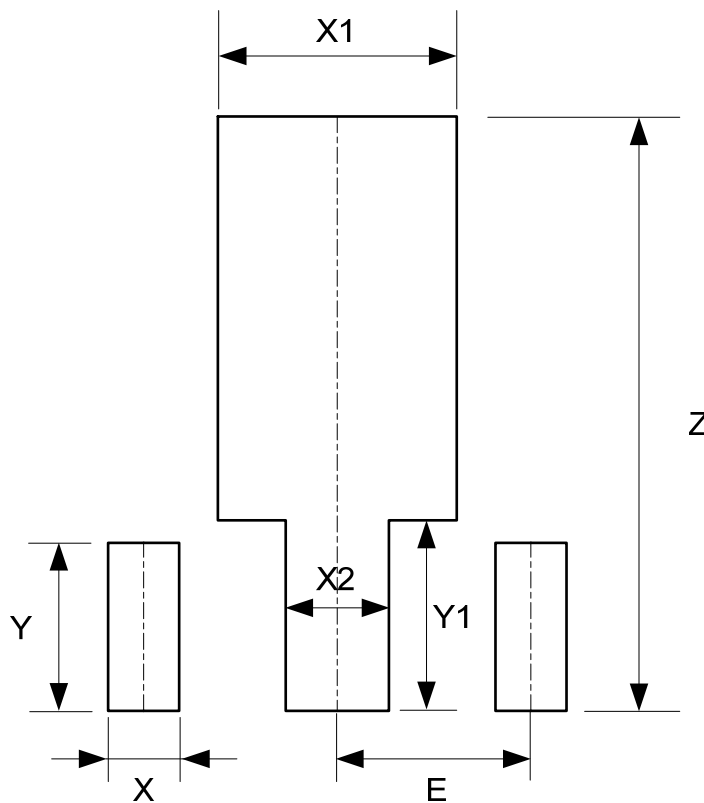
(3) Package Type: SOT-23-5



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E1 (mm)/(inch)	E2 (mm)/(inch)
Value	3.600/0.142	1.600/0.063	0.700/0.028	1.000/0.039	0.950/0.037	1.900/0.075

Suggested Pad Layout (cont.) (All dimensions in mm.)

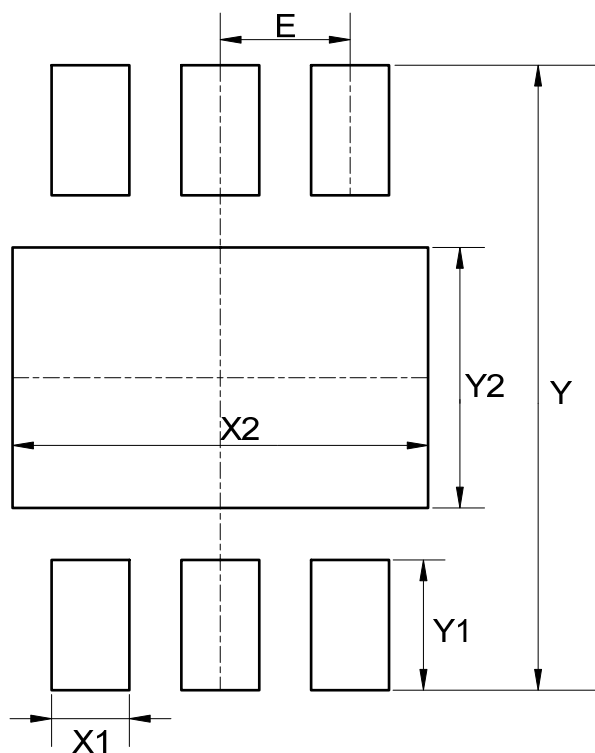
(4) Package Type: SOT-89



Dimensions	Z (mm)/(inch)	X (mm)/(inch)	X1 (mm)/(inch)	X2 (mm)/(inch)	Y (mm)/(inch)	Y1 (mm)/(inch)	E (mm)/(inch)
Value	4.600/0.181	0.550/0.022	1.850/0.073	0.800/0.031	1.300/0.051	1.475/0.058	1.500/0.059

Suggested Pad Layout (cont.) (All dimensions in mm.)

(5) Package Type: DFN-2x2-6



Dimensions	Y (mm)/(inch)	X1 (mm)/(inch)	Y1=E (mm)/(inch)	X2 (mm)/(inch)	Y2 (mm)/(inch)
Value	2.400/0.094	0.300/0.012	0.500/0.020	1.600/0.063	1.000/0.039

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